Exam.Code: 0932 Sub. Code: 6636

2053

B.E. (Electronics and Communication Engineering)

Eighth Semester

EC-814: MEMS and Microsystems

Time allowed: 3 Hours

Max. Marks: 50

NOTE: Attempt <u>five</u> questions in all, including Question No. I which is compulsory and selecting two questions from each Unit.

x-x-x

- I. Answer the following:-a) What is sensor? How does it differ from a transducer?
 - b) What is sputter deposition?
 - c) Define thermal micro defector.
 - d) Write short note on diffusion and oxidation.
 - e) What is bulk micromachining?

(5x2)

UNIT-I

- II. Discuss the design aspects of flow sensor using the thin film anemometer. (10)
- III. a) Write short notes on optical sensors, pressure sensors and thermal sensors.
- b) What do you understand from actuation using electrostatic forces? (2x5)
- IV. a) List out the difference between microelectronics and MEMS.
 - b) Explain thermopile detectors on membrane.

(2x5)

UNIT - II

- V. Explain in detail about surface micromachining and LGA process. (10)
- VI. a) What do you understand from computer aided design and how it is useful in Microsystems design?
 - b) Explain about physical vapor deposition.

(2x5)

- VII. a) Write short notes on epitaxy and etching.
 - b) Explain the process of photolithography in detail.

(2x5)